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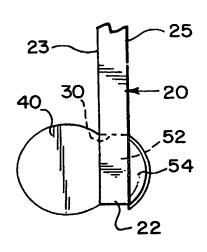
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(54) Title: SOLDER-BEARING ARTICLES AND METHOD OF RETAINING A SOLDER MASS THEREON



(57) Abstract: A method of retaining a solder mass (40) to a solder-bearing article (20) is provided and includes the steps of: (a) disposing a length of solder mass over at least some of the plurality of openings (30); and forming a plurality of solder rivets along the length of the solder mass. The solder rivets serve to retain the length of solder mass to the solder-bearing article. The solder-bearing article includes any number of different types of components where a solder mass is held thereby, e.g., leads, terminals, connectors, electromagnetic shields, etc.